

RAD-5000VS12



Outline

- -Fully-automatic barcode lable printing and attachment system, used after wafer ID is recognized via monitor.
- -Ability to read attached barcode label for checking.
- -Ability to operate in-line with Lintec's fully-automatic wafer mounter.

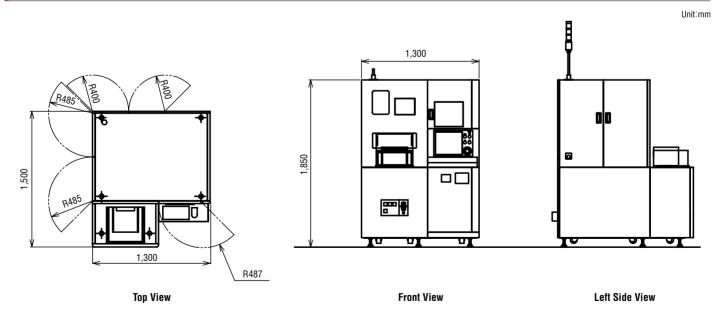
Option ·Host Communication Function (Communication Format :
Conforms to SECS-I and HSMS/Software : Conforms to GEM)

External View

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Power Supply	Voltage	: AC200-230V ±10% (AC190-253V)
	Frequency	: 50/60Hz
	Phase	: single phase
	Power consumption	: 1.0kW
Air Supply	Air pressure	: 0.5-0.8MPa
	Air consumption	: >200L/min (ANR)
Vacuum Supply	Vacuum pressure	:>-80kPa
Applicable Wafer Size	200mm, 300mm	
Size	Width: 1,300mm	BALAN
	Depth: 1,500mm	
	Height: 1,850mm	
	(excluding the signal	tower)
Weight	1,000kg	
UPH	80wafers/hour	

printing frequency.)

(This may vary depending on character position and



Facility

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